

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT4157622

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
NATHAPONG SUTHIWONGSUNTHORN	02/10/2016
ANTONIO JR. BAMBALAN DIMAANO	02/03/2016
RUI HUANG	02/10/2016
HUA HONG TAN	02/10/2016
KRIANGSAK SAE LE	05/26/2016
BENG YEUNG HO	08/11/2015
ROEL ADEVA ROBLES	02/10/2016
WEDANNI LINSANGAN MICLA	08/11/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	UTAC HEADQUARTERS PTE. LTD.
<b>Street Address:</b>	22 ANG MO KIO INDUSTRIAL PARK 2
<b>City:</b>	SINGAPORE
<b>State/Country:</b>	SINGAPORE
<b>Postal Code:</b>	569506
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15361487
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(656)846-2005
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<b>Correspondent Name:</b>	HORIZON IP PTE LTD
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<b>Address Line 4:</b>	SINGAPORE, SINGAPORE 199591
<b>ATTORNEY DOCKET NUMBER:</b>	UTACP2014NAT62US1
<b>NAME OF SUBMITTER:</b>	CARMEN S. NG
<b>SIGNATURE:</b>	/Carmen S. Ng/

PATENT

DATE SIGNED:	11/27/2016
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**Total Attachments: 11**

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## ASSIGNMENT

For good and valuable consideration, we, Nathapong SUTHIWONGSUNTHORN, residing at 509 Sembawang Road, 04-63, Singapore 757710, a citizen of Singapore; Antonio Jr. Bambalan DIMAANO, residing at BLK 356A, Admiralty Drive, #07-82, Singapore 751356, a citizen of Republic of Philippines; Rui HUANG, residing at BLK 545 Choa Chu Kang St. 52 #05-04, Singapore 680545, a citizen of People's Republic of China; Hua Hong TAN, residing at BLK 626 Bedok Reservoir Road #11-1584, Singapore 470626, a citizen of Singapore; Kriangsak Sae LE, residing at Condo Ideo mix Sukhumvit 103, 9/1082 floor 18 Soi Udomsuk 3 Bangna, Bangkok 10260, Thailand, a citizen of Malaysia; Beng Yeung HO, residing at Blk 128D Punggol Field Walk #17-325, Singapore 824128, a citizen of Singapore; Nelson Agbisit DE VERA, residing at Blk 644 Woodlands Ring Road #03-20, Singapore 730644, a citizen of Singapore; Roel Adeva ROBLES, residing at Blk 290B #09-38 Compassvale Cres., Singapore 542290, a citizen of Republic of Philippines; Wedanni Linsangan MICLA, residing at 853, Woodlands St. 83, 03-122, Singapore 730853, a citizen of Republic of Philippines;

Hereby sell or have sold, assign or have assigned, and transfer or have transferred to **UTAC Headquarters Pte. Ltd.**, a corporation of **Singapore**, having its principal place of business at **22 Ang Mo Kio Industrial Park 2, Singapore 569506**,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently here within, and is entitled:

## SEMICONDUCTOR PACKAGES AND METHODS OF PACKAGING

### SEMICONDUCTOR DEVICES

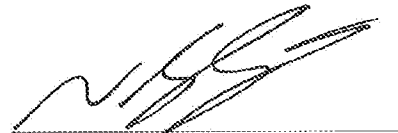
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States

and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 10 Feb 2016

  
\_\_\_\_\_  
(Signature)

Nathapong

SUTHIWONGSUNTHORN

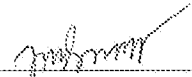
Witness 1: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Witness 2: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Date: FEB 03, 2016

  
(Signature)

Antonio Jr. Bambalan

**DIMAANO**

Witness 1: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Witness 2: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Date: 10 Feb 2016

  
(Signature)  
Rui HUANG

Witness 1:  
\_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Witness 2:  
\_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Date: 10 Feb 2016



(Signature)

Hua Hong TAN

Witness 1:

(Signature)

(Print name)

Witness 2:

(Signature)

(Print name)



Date: 26 May 2016

  
(Signature)

Kriangsak Sae LE

Witness 1: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Witness 2: \_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)


Date: 08/11/2015

  
(Signature)

Beng Yeung HO

Witness 1:   
(Signature)

JAMES TAN  
(Print name)

Witness 2:   
(Signature)

CC Amy  
(Print name)

*Date:* \_\_\_\_\_

\_\_\_\_\_  
*(Signature)*

Nelson Agbisit DE VERA


*Witness 1:* \_\_\_\_\_  
*(Signature)*

\_\_\_\_\_  
*(Print name)*

*Witness 2:* \_\_\_\_\_  
*(Signature)*

\_\_\_\_\_  
*(Print name)*

Date: 10 Feb 2016

  
\_\_\_\_\_  
(Signature)  
Roel Adeva ROBLES

Witness 1: \_\_\_\_\_  
(Signature)  
\_\_\_\_\_  
(Print name)

Witness 2: \_\_\_\_\_  
(Signature)  
\_\_\_\_\_  
(Print name)

Date: 11 Aug 2018

  
(Signature)

Wedanni Linsangan MICLA

Witness 1:  
\_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)

Witness 2:  
\_\_\_\_\_  
(Signature)

\_\_\_\_\_  
(Print name)